# APDS-9005

Miniature Surface-Mount Ambient Light Photo Sensor



# **Data Sheet**



# Description

The APDS-9005 is a low cost analog-output ambient light photo sensor in miniature chipLED lead-free surface mount package. It consists of a photo sensor, whose spectral response is close to the CIE standard photopic observer, as show in figure 2. The APDS-9005 is ideal for applications in which the measurement of ambient light is used to control display backlighting. Mobile appliances such as the mobile phones and PDAs that draw heavy current from display backlighting will benefit from incorporating these photo sensor products in their designs by reducing power consumption significantly.

### **Application Support Information**

The Application Engineering Group is available to assist you with the application design associated with APDS-9005 ambient light photo sensor module. You can contact them through your local sales representatives for additional details.

#### Features

- Spectral responsivity close to that of human eye
- Miniature ChipLED Leadfree surface-mount package Height – 0.55 mm Width – 1.60 mm Depth – 1.50 mm
- Low sensitivity variation across various light sources
- Recommended operating temperature : -40°C to 85°C
- Vcc supply 1.8 to 5.5V
- Lead-free package, RoHS compliance
- Output linearity across wide illumination range

#### Applications

• Detection of ambient light to control display backlighting

Mobile devices – Mobile phones, PDAs Computing devices – Notebooks, Webpads Consumer devices – TVs, Video Cameras, Digital Still Camera

- Automatic Residential and Commercial Lighting Management
- Electronic Signs and Signals

# **Ordering Information**

Part Number	Packaging Type	Package	Quantity
APDS-9005-020	Tape and Reel	6-pins Chipled package	2500
Typical Applicat	ion Circuit		
Pin 1: APDS-9005 Pin 2,3,4,5 : N	Pin 6:OUT	RLOAD	

# I/O Pins Configuration Table

Pin Symbol		Description	
1	VCC	VCC	
2	NC	No Connect	
3	NC	No Connect	
4	Nc	No Connect	
5	NC	No Connect	
6	lout	Out	

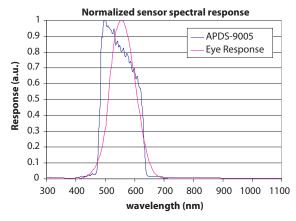


Figure 1. Typical application circuit for APDS-9005

Component	Recommended Application Circuit Component			
RLOAD	1k ohm			
Note :				

Refer to Figure 11 for General Luminance Vs Typical Output Voltage for different RLOAD values  $% \mathcal{T}_{\mathrm{A}}$ 

Figure 2. Relative Spectral Response Vs Wavelength

CAUTIONS : It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation which may be induced by ESD

# **Absolute Maximum Ratings**

For implementations where case to ambient thermal resistance is  $\leq$  50 °C /W

Parameter	Symbol	Min.	Max.	Units
Storage Temperature	Ts	-40	85	°C
Operating temperature	T <sub>A</sub>	-40	85	°C
Supply Voltage	V <sub>CC</sub>	0	6	V

# **Recommended Operating Conditions**

Parameter	Symbol	Min.	Max.	Units	Conditions
Supply Voltage	V <sub>CC</sub>	1.8	5.5	٧	

# Electrical & Optical Specifications (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Photo Current (I)	I_PH1	28	40	52	uA	Vcc = 1.8V, Lux = 100 (2)
Photo Current (II)	I_PH2	-	44	-	uA	Vcc =1.8V, Lux = 100 (1)
Dark Current	I_DARK	-	300	-	nA	Vcc = 3V, $Lux = 0$
Light Current Ratio	I_ <sub>PH3</sub> / I_ <sub>PH2</sub>	-	1.1	-	-	
Rise Time	T <sub>r</sub>	-	5	-	ms	RI = 1Kohm, Lux = 100
Fall Time	T <sub>f</sub>	-	5	-	ms	R1 = 1Kohm, Lux=100
Peak sensitivity wavelength	λ	-	500	-	nm	
Settling Time pulsed at Vcc	T <sub>set</sub>	-	10	-	ms	Vcc pulsed = 0V to 3V; Rload = 2.4K ohms; Lux = 100 $^{(2)}$
Propagation delay	T <sub>d</sub>	-	5	-	ms	RI = 1Kohm, Lux = 100
Storage delay	Ts	-	5	-	ms	R1 = 1Kohm, Lux=100
Saturation voltage	Vsat	1.0	-	-	V	R1 = 150Kohm, Lux = 100

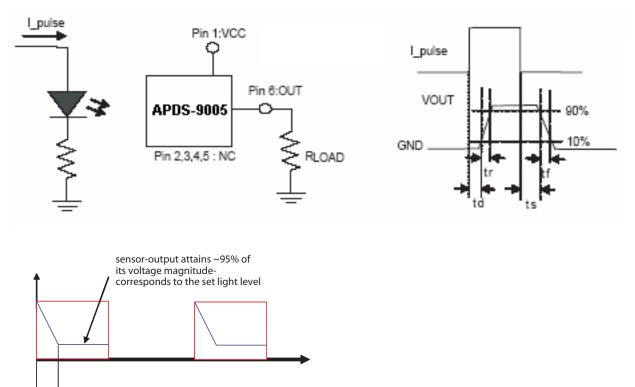
Note :

1) Illuminance by incandescent lamp

2) White LED is used as light source

Tset

# Light Measurement Circuit and Waveforms



VCC Pulse from PG

Sensor Output at Load

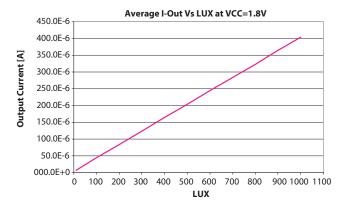


Figure 3. Average lout Vs Lux (Vcc = 1.8V, T=25°C, White LED source)

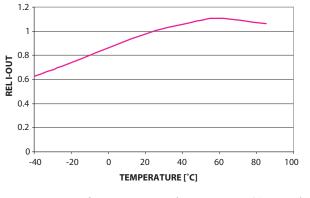
1.2

1.0

0.8

0.2

**BET I-OUT** 0.6 0.4



AVG REL-IOUT Vs TEMP at 100LUX/1.8V

Figure 4. Average relative lout Vs Temp (Vcc = 1.8V, T=25°C, 100 Lux)

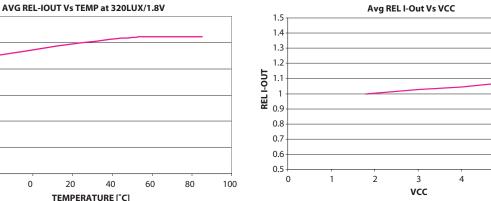


Figure 6. Relative Output Current Vs Vcc (Ta = 25°C, 100Lux)

5

6

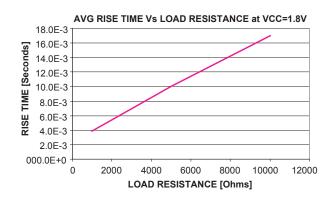


Figure 8. Average Rise Time Vs Load Resistance at Vcc = 1.8V

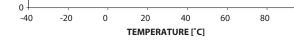
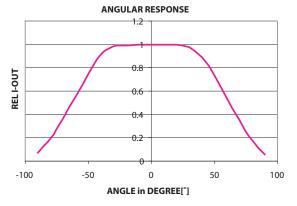
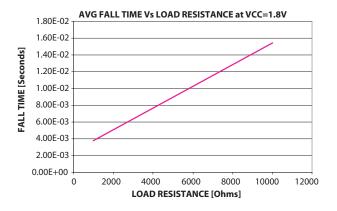


Figure 5. Relative Output Current Vs Temp (Vcc = 1.8V, 100 Lux)







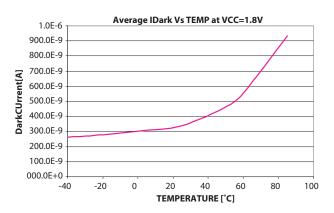
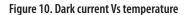


Figure 9. Average Fall Time Vs Load Resistance at Vcc = 1.8V



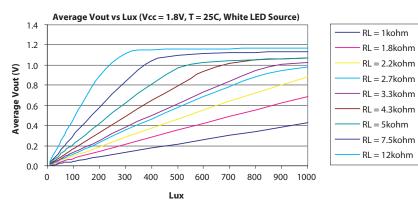
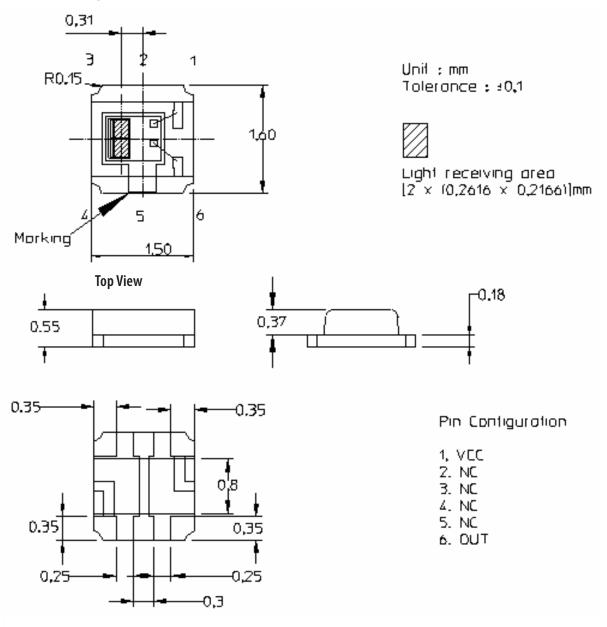
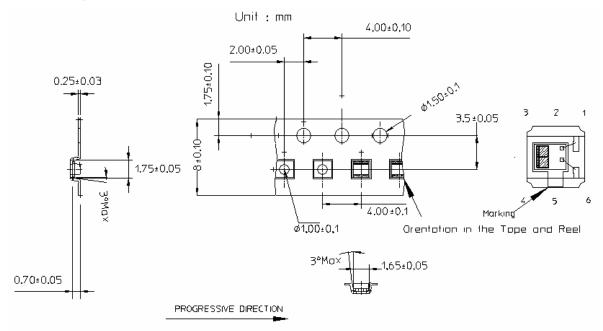


Figure 11. General Luminance vs Typical Output Voltage (Vcc = 1.8V, T = 25°C, Light Source = White LED)

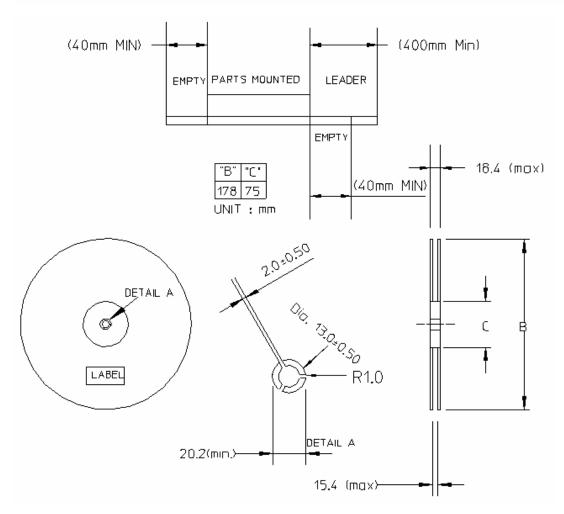


**Bottom View** 

## **APDS-9005 Tape and Reel Dimension**

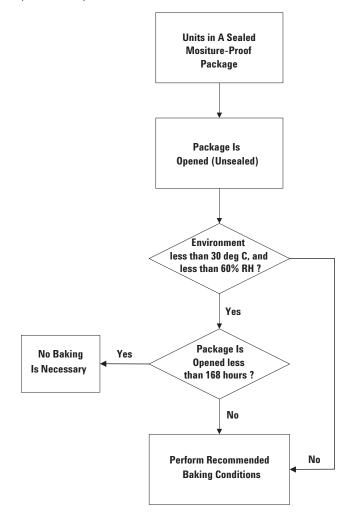


Material of Carrier Tape : Canductive Polystrene Material of Cover Tape : PVC Method of Cover : Heat Sensitive Adhesive



#### **Moisture Proof Packaging**

All APDS-9005 options are shipped in moisture proof package. Once opened, moisture absorption begins. This part is compliant to JEDEC Level 3.



#### **Baking Conditions:**

If the parts are not stored in dry conditions, they must be baked before reflow to prevent damage to the parts.

Package	Temperature	Time
In Reel	60°C	48 hours
In Bulk	100°C	4 hours

Baking should only be done once.

#### **Recommended Storage Conditions:**

Storage Temperature	10 °C to 30 °C	
Relative Humidity	below 60% RH	

Time from unsealing to soldering:

After removal from the bag, the parts should be soldered within 7 days and if stored at the recommended storage conditions. If times longer than 7 days are needed, the parts must be stored in a dry box.

## **Recommended Reflow Profile**

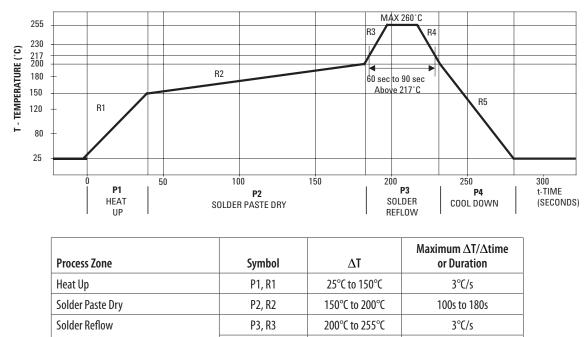
Cool Down

**Peak Temperature** 

Time maintained above 217°C

Time 25°C to Peak Temperature

Time within 5°C of actual Peak Temperature



P3, R4

P4, R5

The reflow profile is a straight-line representation of a nominal temperature profile for a convective reflow solder
process. The temperature profile is divided into four process zones, each with different $\Delta T/\Delta$ time temperature change
rates or duration. The $\Delta T/\Delta t$ ime rates or duration are detailed in the above table. The temperatures are measured at
the component to printed circuit board connections.

255°C to 200°C

200°C to 25°C

> 217°C

260°C

> 255°C

25°C to 260°C

-6°C/s

-6°C/s

60s to 90s

20s to 40s

8mins

**Process zone P1**, the PC board and APDS-9005 pins are heated to a temperature of 150°C to activate the flux in the solder paste. The temperature ramp up rate, R1, is limited to 3°C per second to allow for even heating of both the PC board and APDS-9005 pins.

**Process zone P2** should be of sufficient time duration (100 to 180 seconds) to dry the solder paste. The temperature is raised to a level just below the liquidus point of the solder, usually 200°C (392°F).

**Process zone P3** is the solder reflow zone. In zone P3, the temperature is quickly raised above the liquidus point of solder to 255°C (491°F) for optimum results. The dwell time above the liquidus point of solder should be between 20 and 40 seconds. It usually takes about 20 seconds to assure proper coalescing of the solder balls into liquid solder and the formation of good solder connections. Beyond a dwell time of 40 seconds, the intermetallic growth within the solder connections becomes excessive, resulting in the formation of weak and unreliable connections. The temperature is then rapidly reduced to a point below the solidus temperature of the solder, usually 200°C (392°F), to allow the solder within the connections to freeze solid.

**Process zone P4** is the cool down after solder freeze. The cool down rate, R5, from the liquidus point of the solder to 25°C (77°F) should not exceed 6°C per second maximum. This limitation is necessary to allow the PC board and APDS-9005 pins to change dimensions evenly, putting minimal stresses on the APDS-9005.

It is recommended to perform reflow soldering no more than twice.

## **Appendix A: SMT Assembly Application Note**



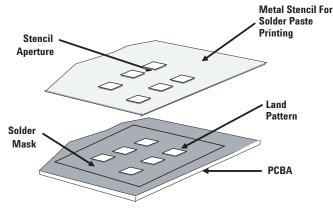


Figure A1. Stencil and PCBA

#### 1.1 Recommended Land Pattern

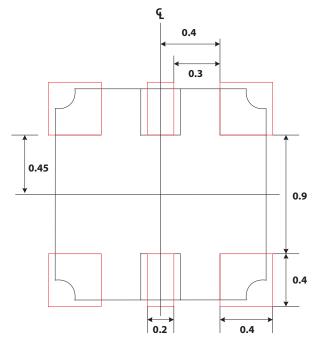


Figure A2. Recommended Land Pattern

#### 1.2 Recommended Metal Solder Stencil Aperture

It is recommended that a 0.11 mm (0.004 inches) thick stencil be used for solder paste printing. Aperture opening for shield pad is 0.4mm x 0.4mm and 0.2mm x 0.4mm (as per land pattern). This is to ensure adequate printed solder paste volume and no shorting.

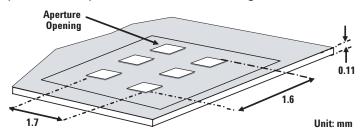


Figure A3. Solder Stencil Aperture

# 1.3 Adjacent Land Keepout and Solder Mask Areas

Adjacent land keep-out is the maximum space occupied by the unit relative to the land pattern. There should be no other SMD components within this area.

The minimum solder resist strip width required to avoid solder bridging adjacent pads is 0.2 mm.

Note: Wet/Liquid Photo-Imageable solder resist/mask is recommended.

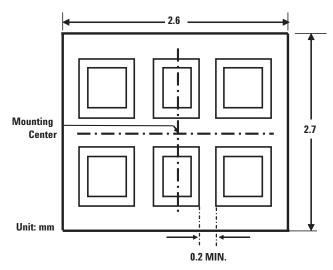


Figure A4 Adjacent Land Keepout and Solder Mask Areas

#### Appendix B: Optical Window Design for APDS-9005

#### 2.0 Optical Window Dimensions

To ensure that the performance of the APDS-9005 will not be affected by improper window design, there are some constraints on the dimensions and design of the window. There is a constraint on the minimum size of the window, which is placed in front of the photo light sensor, so that it will not affect the angular response of the APDS-9005. This minimum dimension that is recommended will ensure at least a  $\pm 35^{\circ}$  light reception cone.

If a smaller window is required, a light pipe or light guide can be used. A light pipe or light guide is a cylindrical piece of transparent plastic, which makes use of total internal reflection to focus the light.

The thickness of the window should be kept as minimum as possible because there is a loss of power in every optical window of about 8% due to reflection (4% on each side) and an additional loss of energy in the plastic material.

Figure B1 and B2 illustrate the two types of window that we have recommended which could either be a flat window or a flat window with light pipe.

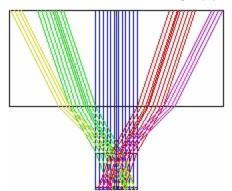


Figure B1. Window Size Determination for Flat Window

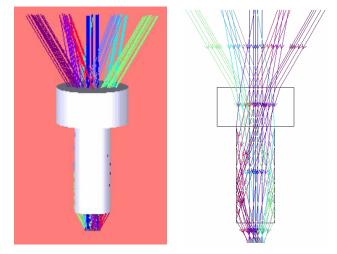
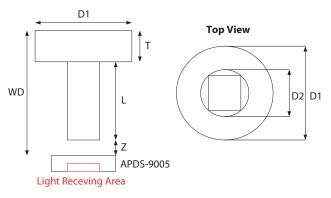


Figure B2. Window Design of Flat Window with Light Guide

Table 1 and Figure B3 below show the recommended dimensions of the window. These dimension values are based on a window thickness of 1.0mm with a refractive index 1.585.



#### Figure B3. Recommended Window Dimensions

- WD: Working Distance between window front panel & APDS-9005
- D1: Window Diameter
- T: Thickness
- L: Length of Light Pipe
- D2: Light Pipe Diameter
- Z: Distance between window rear panel and APDS-9005

Table 1. Recommended minimum dimension for optical window

WD	Flat Wi (L=0			window ight Pipe
(T+L+Z)	Z	Z D1		T/L/Z
1.5	0.5	2.05	-	-
2.0	1.0	2.75	-	-
2.5	1.5	3.45	-	-
3.0	2.0	4.15	2.0/1.2	1.0/1.5/0.5

#### All dimensions are in mm

The window should be placed directly on top of the light receiving area (active area) of the photo sensor to achieve better performance and if a flat window with a light pipe is used, dimension D2 should be 1.2mm to optimize the performance of APDS-9005.

The recommended minimum window dimension is based on the assumption that the center of the window and the center of the light receiving of the photo sensor are the same. It is recommended that the tolerance for assembly be considered as well. The recommended minimum window size which will take into account of the assembly tolerance is defined as:

D1 (min + assembly tolerance) = D1min + 2\*(assembly tolerance) (Dimensions are in mm)

D2 (min + assembly tolerance) = D2min + 2\*(assembly tolerance) (Dimensions are in mm)

#### 2.1 Optical Window Material

The material of the window is recommended to be polycarbonate. The surface finish of the plastic should be smooth, without any texture.

The recommended plastic material for use as a window is available from Bayer AG and Bayer Antwerp N. V. (Europe), Bayer Corp.(USA) and Bayer Polymers Co., Ltd. (Thailand), as shown in Table 2.

#### **Table 2. Recommended Plastic Materials**

	Visible	
Material number	light transmission	Refractive index
Makrolon LQ2647	87%	1.587
Makrolon LQ3147	87%	1.587
Makrolon LQ3187	85%	1.587

#### **Appendix C : General Application Guide for APDS-9005**

The APDS-9005 is a low cost analog-output ambient light photo sensor whose spectral response closely emulates the human eyes. APDS-9005 consists of a photo sensor that is able to produce a high gain photo current to a sufficient level that can be converted to voltage with a standard value of external resistor. APDS-9005 can easily be integrated into systems that use ADC input which is available for sampling of the external source, as shown in figure C1 below.

The amount of converted voltage, Vout, is mainly dependant proportionally on the photo current which generated by the brightness of the light shone on the photo sensor and the load resistor used, RL. Increasing the brightness of the light or/and the load resistor will increase the output voltage.

Brightness is measured as "LUX" unit, which describes how intense a light source that our eyes perceive. LUX meter is the equipment for "LUX" measurement. Light sources with the same LUX level appear at the same brightness to the human eyes.

Selection of the load resistor RL will determine the amount of current-to-voltage conversion in the circuit.

Light source e.g. fluorescent light consists of ac noise frequency of about 100Hz. A capacitor of 10uF, which act as a low-pass filter, is recommended to add in parallel with the load resistor to reduce the ripples.

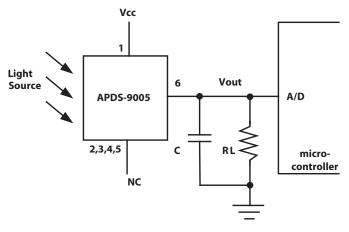


Figure C1. Configuration of APDS-9005

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